Pedro LÃ³pez

List of Publications by Year in descending order

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Ρεπραί Δ3σετ

#	Article	IF	CITATIONS
1	Atomistic analysis of the evolution of boron activation during annealing in crystalline and preamorphized silicon. Journal of Applied Physics, 2005, 97, 103520.	2.5	34
2	Physical insight into boron activation and redistribution during annealing after low-temperature solid phase epitaxial regrowth. Applied Physics Letters, 2006, 88, 191917.	3.3	22
3	Improved atomistic damage generation model for binary collision simulations. Journal of Applied Physics, 2009, 105, 083530.	2.5	22
4	Atomistic modeling of dopant implantation and annealing in Si: damage evolution, dopant diffusion and activation. Computational Materials Science, 2005, 33, 92-105.	3.0	21
5	Role of silicon interstitials in boron cluster dissolution. Applied Physics Letters, 2005, 86, 031908.	3.3	16
6	Atomistic analysis of the annealing behavior of amorphous regions in silicon. Journal of Applied Physics, 2007, 101, 093518.	2.5	14
7	Evolution of boron-interstitial clusters in preamorphized silicon without the contribution of end-of-range defects. Materials Science and Engineering B: Solid-State Materials for Advanced Technology, 2008, 154-155, 247-251.	3.5	7
8	Molecular dynamics simulation of the early stages of self-interstitial clustering in silicon. Materials Science in Semiconductor Processing, 2016, 42, 235-238.	4.0	7
9	Improved physical models for advanced silicon device processing. Materials Science in Semiconductor Processing, 2017, 62, 62-79.	4.0	5
10	The role of silicon interstitials in the deactivation and reactivation of high concentration boron profiles. Materials Science and Engineering B: Solid-State Materials for Advanced Technology, 2004, 114-115, 193-197.	3.5	4
11	On the anomalous generation of {0 0 1} loops during laser annealing of ion-implanted silicon. Nuclear Instruments & Methods in Physics Research B, 2019, 458, 179-183.	1.4	4
12	Simulation of p-n junctions: Present and future challenges for technologies beyond 32 nm. Journal of Vacuum Science and Technology B:Nanotechnology and Microelectronics, 2010, 28, C1A1-C1A6.	1.2	3
13	l <inf>ON</inf> Degradation in Si Devices in Harsh Radiation Environments: Modeling of Damage-Dopant Interactions. , 2018, , .		2
14	Atomistic analysis of B clustering and mobility degradation in highly Bâ€doped junctions. International Journal of Numerical Modelling: Electronic Networks, Devices and Fields, 2010, 23, 266-284.	1.9	1
15	Carrier mobility degradation in highly B-doped junctions. , 2009, , .		1
16	Simulation study of ion implanted defects associated to luminescence centers in silicon. , 2011, , .		1
17	Identification of Extended Defect Atomic Configurations in Silicon Through Transmission Electron Microscopy Image Simulation. Journal of Electronic Materials, 2018, 47, 4955-4958.	2.2	1
18	Extending defect models for Si processing: The role of energy barriers for defect transformation, entropy and coalescence mechanism. Nuclear Instruments & Methods in Physics Research B, 2022, 512, 54-59.	1.4	1

#	Article	IF	CITATIONS
19	Atomistic modeling of laser-related phenomena. , 2021, , 79-136.		Ο